- Noninverter With Open-Collector Outputs
- Package Options Include Plastic Small-Outline (D) Packages and Standard Plastic (N) 300-mil DIPs

### description

The SN74ALS35A contains six independent noninverters with open-collector outputs. They perform the Boolean function Y = A. The open-collector outputs require pullup resistors to perform correctly. These outputs may be connected to other open-collector outputs to implement active-low wired-OR or active-high wired-AND functions. Open-collector devices are often used to generate higher V<sub>OH</sub> levels.

The SN74ALS35A is characterized for operation from 0°C to 70°C.

D OR N PACKAGE (TOP VIEW)								
1A [ 1	14 VCC							
1Y [ 2	13 6A							
2A [ 3	12 6Y							
2Y [ 4	11 5A							
3A [ 5	10 5Y							
3Y [ 6	9 4A							
GND [ 7	8 4Y							

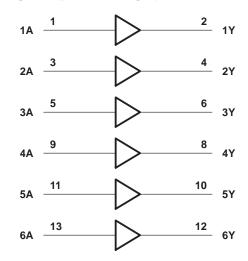
FUNCTION TABLE (each buffer)						
INPUT A	OUTPUT Y					
Н	Н					
L	L					

### logic symbol<sup>†</sup>

1 ^	1	$\wedge$	2	1Y
1A	3	~	4	
2A 3A	5	 	6	2Y 3Y
	9	 	8	
4A	11	 	10	4Y
5A	13	 	12	5Y
6A				6Y

<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

### logic diagram (positive logic)



PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



## SN74ALS35A HEX NONINVERTER WITH OPEN-COLLECTOR OUTPUTS

SDAS011C - DECEMBER 1983 - REVISED DECEMBER 1994

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage, V <sub>CC</sub>
Input voltage, V <sub>1</sub>
Off-state output voltage
Operating free-air temperature range, T <sub>A</sub>
Storage temperature range

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### recommended operating conditions

		MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	V
VIH	High-level input voltage	2			V
$V_{IL}$	Low-level input voltage			0.8	V
VOH	High-level output voltage			5.5	V
IOL	Low-level output current			8	mA
TA	Operating free-air temperature	0		70	°C

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS			
VIK	$V_{CC} = 4.5 V,$	I <sub>I</sub> = -18 mA		-1.2	V
N.e.		$I_{OL} = 4 \text{ mA}$	0.25	0.4	N/
VOL	$V_{CC} = 4.5 V$	I <sub>OL</sub> = 8 mA	0.35	0.5	V
lj	$V_{CC} = 5.5 V,$	$V_{I} = 7 V$		0.1	mA
ЧН	$V_{CC} = 5.5 V,$	$V_{I} = 2.7 V$		20	μΑ
۱ <sub>۱۲</sub>	$V_{CC} = 5.5 V,$	$V_{I} = 0.4 V$		-0.1	mA
ЮН	$V_{CC} = 4.5 V,$	V <sub>OH</sub> = 5.5 V		0.1	mA
ІССН	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 4.5 V	2.7	4.7	mA
ICCL	$V_{CC} = 5.5 V,$	$V_{I} = 0$	4.1	6.3	mA

<sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

### switching characteristics (see Figure 1)

PARAMETER	PARAMETER FROM (INPUT)		V <sub>CC</sub> = 4.5 C <sub>L</sub> = 50 pF R <sub>L</sub> = 2 kΩ T <sub>A</sub> = MIN t	UNIT	
			MIN	MAX	
<sup>t</sup> PLH	٨	×	20	50	
<sup>t</sup> PHL	A	T	2	14	ns

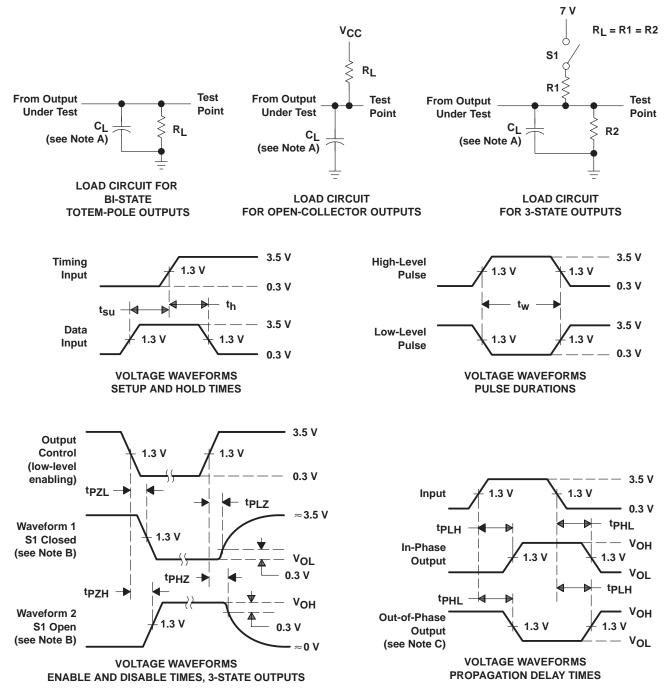
§ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



### SN74ALS35A HEX NONINVERTER WITH OPEN-COLLECTOR OUTPUTS

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#### PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. C<sub>I</sub> includes probe and jig capacitance.

- Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Β. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics:  $PRR \le 1$  MHz,  $t_r = t_f = 2$  ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.





### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN74ALS35AD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS35ADE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS35ADG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS35ADR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS35ADRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS35ADRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS35AN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74ALS35ANE4	ACTIVE	PDIP	Ν	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

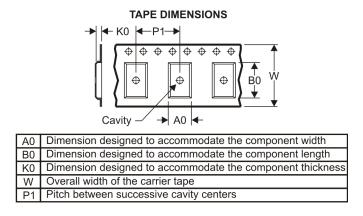
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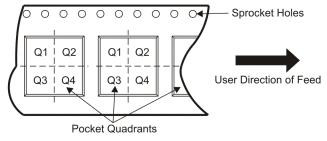
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### TAPE AND REEL INFORMATION





## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal	
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Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALS35ADR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1



# PACKAGE MATERIALS INFORMATION

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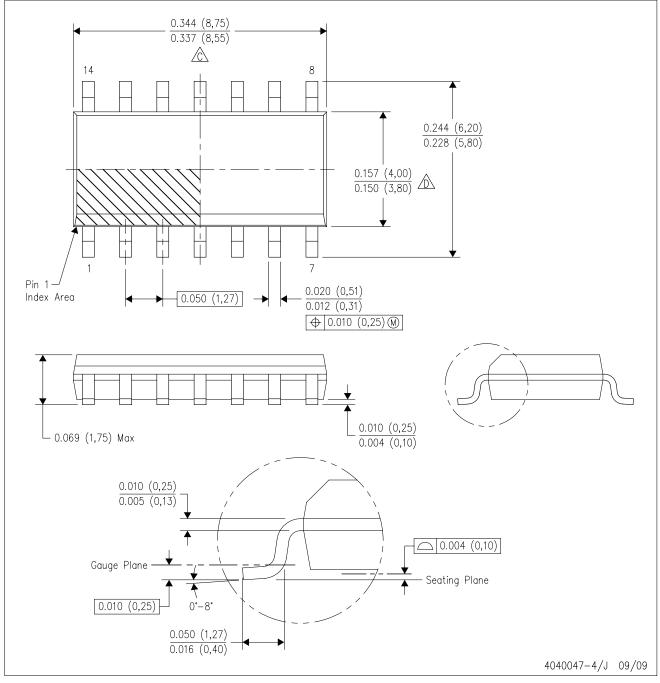


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ALS35ADR	SOIC	D	14	2500	346.0	346.0	33.0

D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AB.



# N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



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